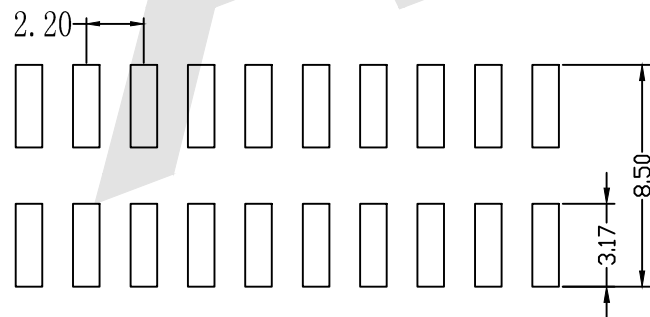
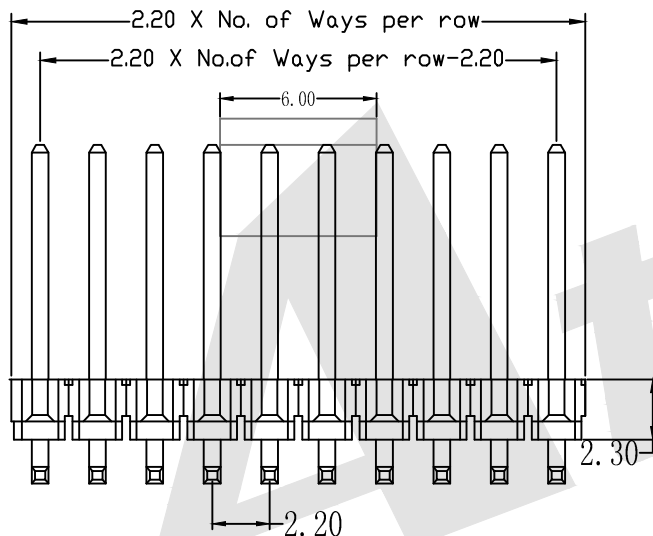
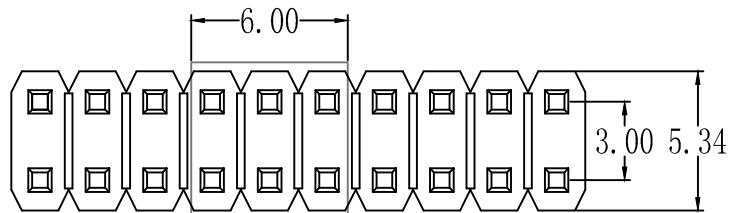


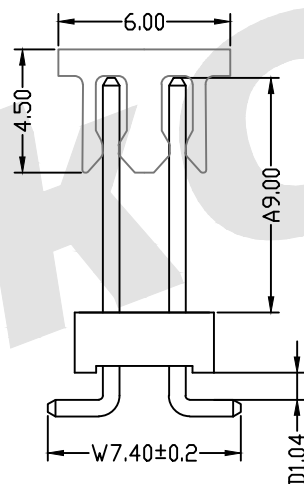
HSF



ROHS



PCB LAYOUT



SPECIFICATION

Current Rating:	3 Amp
Insulation Resistance:	1000M ohms min
Contact Resistance:	20M ohms max
Dielectric Withstanding:	AC500V
Operating Temperature:	-65° C to +125° C
Contact Material:	Brass
Insulator Material:	PA9T, UL 94V-0 Black

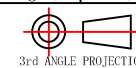
Ordering Code:

PHIM01 - X - X - D - A-D-W - X - X - X
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧

- ① Series No:
- ② No. of Contacts
02 To 80
- ③ Contact Plating:
G0:Gold flash S0:Selective
G1:3u" Gold S1:Selective 3u"
G2:5u" Gold S2:Selective 5u"
G3:10u" Gold S3:Selective 10u"
G4:15u" Gold S4:Selective 15u"
G5:30u" Gold S5:Selective 30u"
SN:Tin
- ④ Connector Type
D: Dual
- ⑤ Pin Length:
A:0900=9.00mm
D:0104=1.04mm
W:0740=7.40mm
Please mark the desired length in the A/D/W
- ⑥ Insulator Material
E:PA9T
- ⑦ Packing
A:Tray B:Bag
T:Tube U:Tube+CAP
R:Tape&Reel
W:Tape&Reel+CAP
- ⑧ Plastic High
H:2.30mm

Unless Otherwise specified tolerance
 X. ±0.35 X.XX: ±0.20
 X.X: ±0.25 X.XXX: ±0.15

SCALE: As Shown	UNIT: mm
DRAW ZLA	DATE 24/04/2022
CHECK BobYang	DATE 24/04/2022



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TITLE:
2.2X3.0X2.3mm Pin Header DualRow SMT Type

DRAWING NO: PHIM01-XXD-0900-0104-0740-XXX
 PRODUCT NO: PHIM01-XXD-0900-0104-0740-XXX

REV	DESCRIPTION	DATE